

Data sheet

SAW duplexer
Automotive telematics
LTE band 8

Series/type: B4432

Ordering code: B39941B4432P810

Date: October 23, 2018

Version: 2.0

RF360 products mentioned within this document are products of RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the "RF360 Subsidiaries").



These materials, including the information contained herein, may be used only for informational purposes by the customer. The RF360 Subsidiaries assume no responsibility for errors or omissions in these materials or the information contained herein. The RF360 Subsidiaries reserve the right to make changes to the product(s) or information contained herein without notice. The materials and information are provided on an AS IS basis, and the RF360 Subsidiaries assume no liability and make no warranty or representation, either expressed or implied, with respect to the materials, or any output or results based on the use, application, or evaluation of such materials, including, without limitation, with respect to the non-infringement of trademarks, patents, copyrights or any other intellectual property rights or other rights of third parties.

No use of this documentation or any information contained herein grants any license, whether express, implied, by estoppel or otherwise, to any intellectual property rights, including, without limitation, to any patents owned by QUALCOMM Incorporated or any of its subsidiaries.

Not to be used, copied, reproduced, or modified in whole or in part, nor its contents revealed in any manner to others without the express written permission of RF360 Europe GmbH.

Qualcomm is a trademark of Qualcomm Incorporated, registered in the United States and other countries. Other product and brand names may be trademarks or registered trademarks of their respective owners.

This technical data may be subject to U.S. and international export, re-export, or transfer ("export") laws. Diversion contrary to U.S. and international law is strictly prohibited.



RF360 Europe GmbH
A Qualcomm – TDK Joint Venture

Data sheet

SAW duplexer
Automotive telematics
LTE band 8

Series/type: B4432

Ordering code: B39941B4432P810

Date: October 23, 2018

Version: 2.0

RF360 products mentioned within this document are products of RF360 Europe GmbH and other subsidiaries of RF360 Holdings Singapore Pte. Ltd. (collectively, the "RF360 Subsidiaries").

RF360 Holdings Singapore Pte. Ltd. is a joint venture of Qualcomm Global Trading Pte. Ltd. and EPCOS AG.

RF360 Europe GmbH, Anzinger Str. 13, München, Germany

© 2018 RF360 Europe GmbH and/or its affiliated companies. All rights reserved.



These materials, including the information contained herein, may be used only for informational purposes by the customer. The RF360 Subsidiaries assume no responsibility for errors or omissions in these materials or the information contained herein. The RF360 Subsidiaries reserve the right to make changes to the product(s) or information contained herein without notice. The materials and information are provided on an AS IS basis, and the RF360 Subsidiaries assume no liability and make no warranty or representation, either expressed or implied, with respect to the materials, or any output or results based on the use, application, or evaluation of such materials, including, without limitation, with respect to the non-infringement of trademarks, patents, copyrights or any other intellectual property rights or other rights of third parties.

No use of this documentation or any information contained herein grants any license, whether express, implied, by estoppel or otherwise, to any intellectual property rights, including, without limitation, to any patents owned by QUALCOMM Incorporated or any of its subsidiaries.

Not to be used, copied, reproduced, or modified in whole or in part, nor its contents revealed in any manner to others without the express written permission of RF360 Europe GmbH.

Qualcomm is a trademark of Qualcomm Incorporated, registered in the United States and other countries. Other product and brand names may be trademarks or registered trademarks of their respective owners.

This technical data may be subject to U.S. and international export, re-export, or transfer ("export") laws. Diversion contrary to U.S. and international law is strictly prohibited.



RF360 Europe GmbH A Qualcomm – TDK Joint Venture

Table of contents

1 Application	
2 <u>Features</u>	
3 Package	ξ
4 Pin configuration	
5 Matching circuit.	
6 Characteristics.	
7 Maximum ratings	
8 Transmission coefficients	11
9 Reflection coefficients	
10 <u>EVMs</u>	15
11 Packing material	17
12 Marking	20
13 Soldering profile	21
14 Annotations.	22
15 Cautions and warnings	
16 Important notes	24



RF360 Europe GmbH A Qualcomm – TDK Joint Venture

1 Application

- Low-loss SAW duplexer for band 8 systems
- Low insertion attenuation
- Low amplitude ripple
- Usable pass band 35 MHz
- High isolation between TX and RX

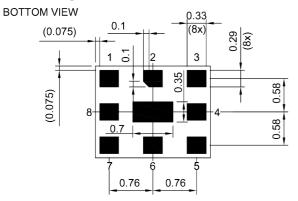
2 Features

- Package size 2.0±0.1 mm × 1.6±0.1 mm
- Package height 0.45 mm (max.)
- Approximate weight 0.02 g
- RoHS compatible
- Package for Surface Mount Technology (SMT)
- Ni/Au-plated terminals
- Filter surface passivated
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 2a (MSL2a)
- AEC-Q200 qualified component family (Grade 3: -40 °C to +85 °C)



Figure 1: Picture of component with example of product marking.

3 Package

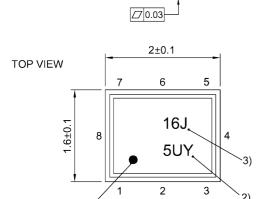


Pad and pitch tolerance ±0.05

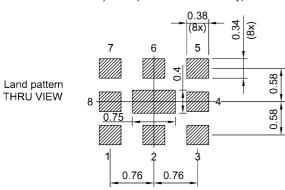
4 Pin configuration

- 1 RX
- 3 TX
- 6 ANT
- 2, 4, 5, 7, Ground 8, 9

SIDE VIEW



- 1) Marking for pad number 1
- 2) Example of encoded lot number
- 3) Example of encoded filter type number



Landing pad tolerance -0.02

Figure 2: Drawing of package with package height A = 0.45 mm (max.). See Sec. Package information (p. 23).

5 Matching circuit

■ L_{p6} = 7.5 nH

■ L_{s3} = 7.9 nH

■ L_{s1} = 2.0 nH

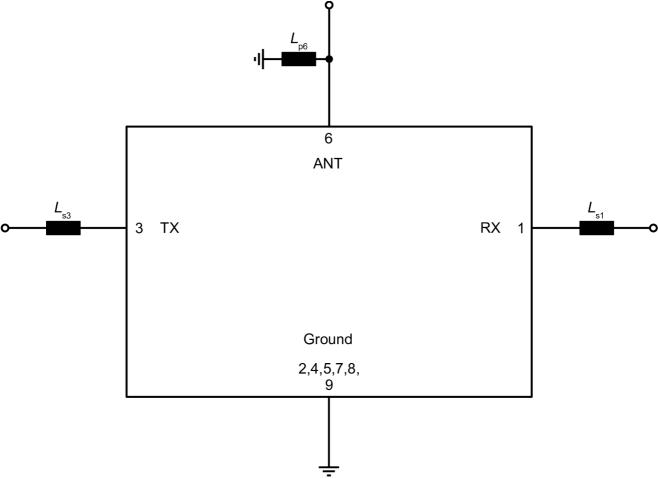


Figure 3: Schematic of matching circuit.



6 Characteristics

6.1 TX - ANT

Temperature range for specification $T_{\rm SPEC} = -40~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$ TX terminating impedance $Z_{\rm TX} = 50~\Omega$ with ser. 7.9 nH¹⁾ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ with par. 7.5 nH¹⁾ RX terminating impedance $Z_{\rm RX} = 50~\Omega$ with ser. 2.0 nH¹⁾

Characteristics TX – ANT				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C		897.5	SPEC —	MHz
Maximum insertion attenuation			α_{max}				
	880 915	MHz		_	2.7	4.32)	dB
	880 915	MHz		_	2.7	5.6	dB
Amplitude ripple (p-p)			Δα				
	880 915	MHz		_	1.6	4.6	dB
Maximum VSWR			$VSWR_{max}$				
@ TX port	880 915	MHz		_	1.7	2.1	
@ ANT port	880 915	MHz		_	1.8	2.1	
Maximum error vector magnitude			EVM _{max} ³⁾				
	882.4 912.6	MHz		_	2.7	8.0	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	50 821	MHz		30	36	_	dB
	821 870	MHz		35	41	_	dB
	925 960	MHz		404)	56	_	dB
	925 960	MHz		37	56	_	dB
	960 2500	MHz		30	34	_	dB
	1565 1606	MHz		40	53	_	dB
	2400 2500	MHz		35	45	_	dB
	2500 2620	MHz		35	45	_	dB
	2620 2745	MHz		35	45	_	dB
	2745 3660	MHz		30	42	_	dB

See Sec. Matching circuit (p. 6).

²⁾ Valid for temperature $T = -20 \,^{\circ}\text{C...} + 55 \,^{\circ}\text{C.}$

³⁾ Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.

Valid for temperature $T = -20 \,^{\circ}\text{C...} + 85 \,^{\circ}\text{C.}$



6.2 ANT - RX

Temperature range for specification = -40 °C ... +85 °C $T_{ ext{SPEC}}$ TX terminating impedance = 50 Ω with ser. 7.9 nH¹⁾ = 50 Ω with par. 7.5 nH¹⁾ ANT terminating impedance RX terminating impedance = 50 Ω with ser. 2.0 nH¹⁾

Characteristics ANT – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{SPEC}} \end{array}$	
Center frequency			f _C	_	942.5	_	MHz
Maximum insertion attenuation			$\boldsymbol{\alpha}_{\text{max}}$				
	925 960	MHz		_	2.9	4.32)	dB
	925 960	MHz		_	2.9	5.6	dB
Amplitude ripple (p-p)			Δα				
	925 960	MHz		_	1.4	4.2	dB
Maximum VSWR			$VSWR_{max}$				
@ ANT port	925 960	MHz		_	1.8	2.1	
@ RX port	925 960	MHz		_	1.8	2.1	
Maximum error vector magnitude			EVM _{max} ³⁾				
	927.4 957.6	MHz		_	3.5	8.5	%
Minimum attenuation			$\boldsymbol{\alpha}_{\text{min}}$				
	50 462	MHz		50	68	_	dB
	462 480	MHz		50	67	_	dB
	480 835	MHz		50	62	_	dB
	835 870	MHz		50	65	_	dB
	870 880	MHz		50	70	_	dB
	880 915	MHz		50	55	_	dB
	980 1045	MHz		20	25	_	dB
	1045 2400	MHz		45	54	_	dB
	2400 2500	MHz		45	54	_	dB
	2500 3660	MHz		45	52	_	dB

See Sec. Matching circuit (p. 6). Valid for temperature *T* = −20 °C...+85 °C. 2)

Error Vector Magnitude (EVM) based on definition in 3GPP TS 25.141.



6.3 TX - RX

Temperature range for specification $T_{\rm SPEC} = -40~{\rm ^{\circ}C}~...~+85~{\rm ^{\circ}C}$ TX terminating impedance $Z_{\rm TX} = 50~\Omega$ with ser. 7.9 nH¹⁾ ANT terminating impedance $Z_{\rm ANT} = 50~\Omega$ with par. 7.5 nH¹⁾ RX terminating impedance $Z_{\rm RX} = 50~\Omega$ with ser. 2.0 nH¹⁾

Characteristics TX – RX				$\begin{array}{c} \text{min.} \\ \text{for } T_{\text{SPEC}} \end{array}$	typ. @ +25 °C	$\begin{array}{c} \text{max.} \\ \text{for } T_{\text{\tiny SPEC}} \end{array}$	
Minimum isolation			$\alpha_{_{min}}$				
	880 915	MHz		54	59	_	dB
	925 960	MHz		40	58	_	dB

¹⁾ See Sec. Matching circuit (p. 6).



7 Maximum ratings

Operable temperature	T _{OP} = -40 °C +85 °C	
Storage temperature	T _{STG} ¹⁾ = -40 °C +85 °C	
DC voltage	$ V_{DC} ^{2)} = 0 \text{ V}$	
Input power	P _{IN}	
@ TX port: 880 915 MHz	t.b.d. dBm	Continuous wave for 5000 h @ 50 °C.
@ TX port: other frequency ranges	10 dBm	

Not valid for packaging material. Storage temperature for packaging material is −25 °C to +40 °C.

²⁾ In case of applied DC voltage blocking capacitors are mandatory.

8 Transmission coefficients

8.1 TX - ANT 0.0 $-\alpha/dB$ 2.0 **.**807 2.54 4.0 6.0 870 880 890 910 930 900 920 f/MHz0.0 20.0 40.0 60.0 80.0 750 800 900 1000 850 1050 950 f/MHz 0.0 20.0 40.0 60.0 80.0 1000 2000 3000 4000 5000 6000 f/MHz

Figure 4: Attenuation TX – ANT.

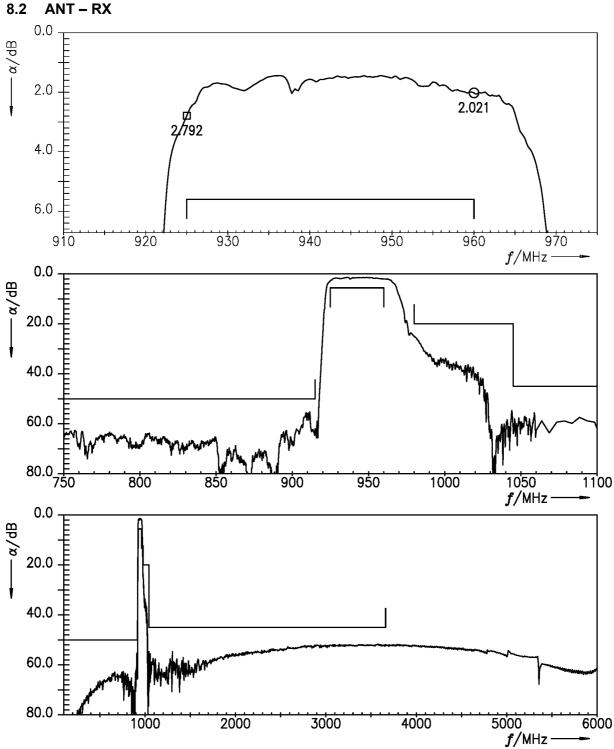


Figure 5: Attenuation ANT – RX.

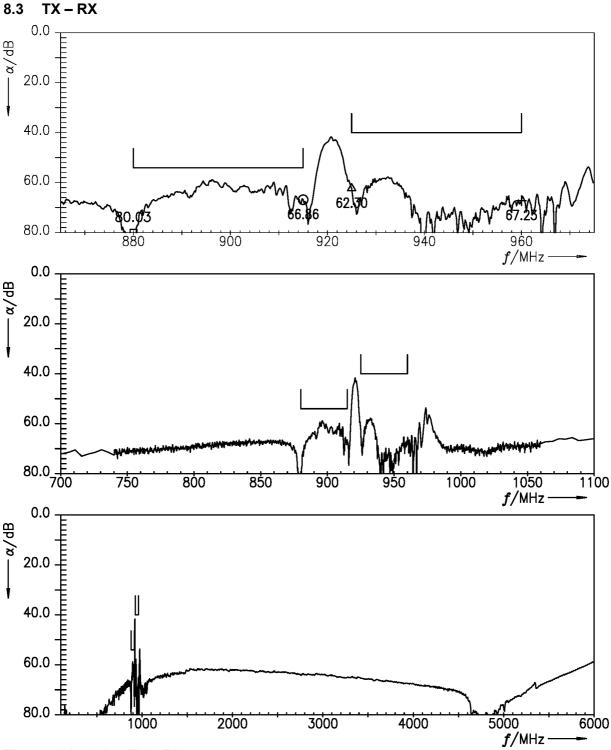
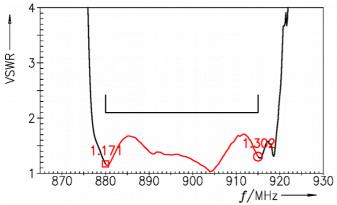


Figure 6: Isolation TX – RX.

9 Reflection coefficients



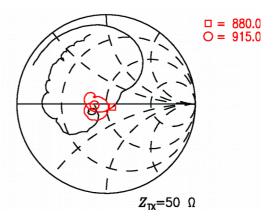
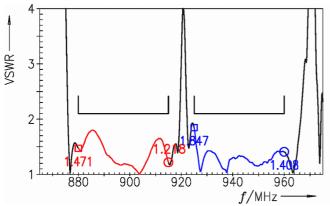


Figure 7: Reflection coefficient at TX port.



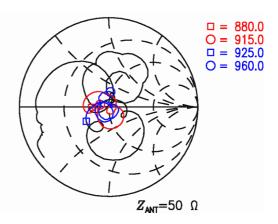
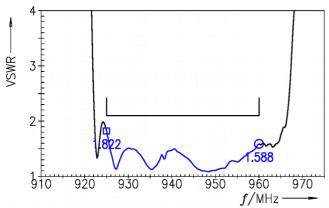


Figure 8: Reflection coefficient at ANT port.



 $\Box = 925.0$ O = 960.0 $Z_{RX} = 50 \Omega$

Figure 9: Reflection coefficient at RX port.

10 EVMs

10.1 TX - ANT

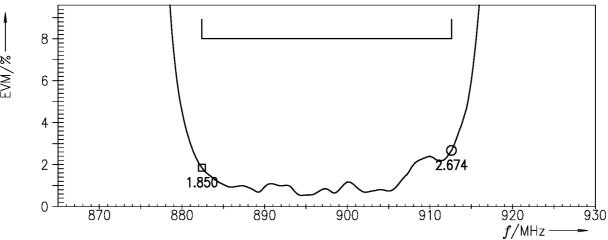


Figure 10: Error vector magnitude TX – ANT.

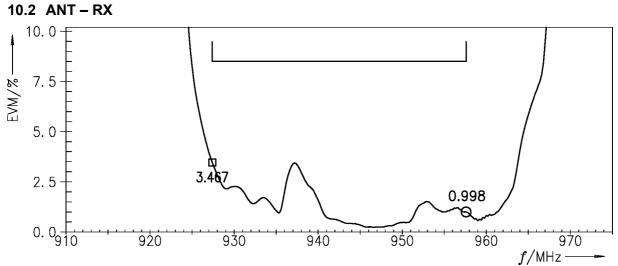


Figure 11: Error vector magnitude ANT – RX.

11 Packing material

11.1 Tape

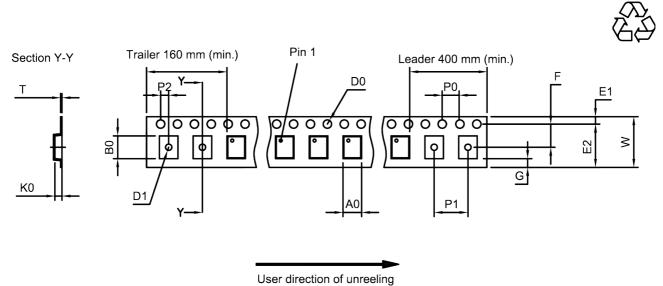


Figure 12: Drawing of tape (first-angle projection) for illustration only and not to scale. The valid tape dimensions are listed in Table 1.

A_0	1.8±0.05 mm	E ₂	6.25 mm (min.)	P ₁	4.0 _{±0.1} mm
B ₀	2.25±0.05 mm	F	3.5±0.05 mm	P ₂	2.0±0.05 mm
D_0	1.5+0.1/-0 mm	G	0.75 mm (min.)	Т	0.25±0.03 mm
D ₁	1.0 mm (min.)	K ₀	0.6±0.05 mm	W	8.0+0.3/-0.1 mm
E ₁	1.75±0.1 mm	P ₀	4.0±0.1 mm		

Table 1: Tape dimensions.

11.2 Reel with diameter of 180 mm

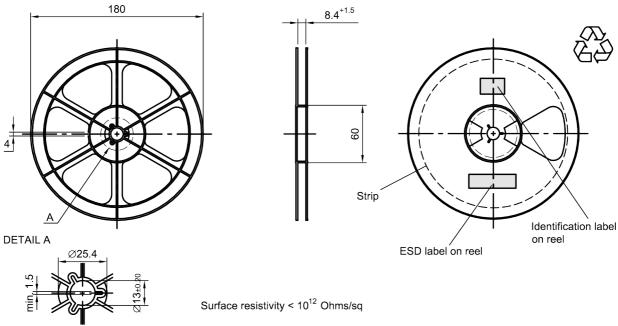


Figure 13: Drawing of reel (first-angle projection) with diameter of 180 mm.

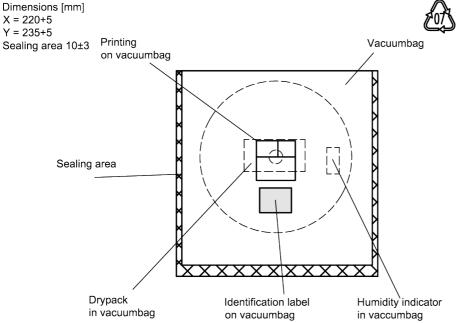


Figure 14: Drawing of moisture barrier bag (MBB) for reel with diameter of 180 mm.

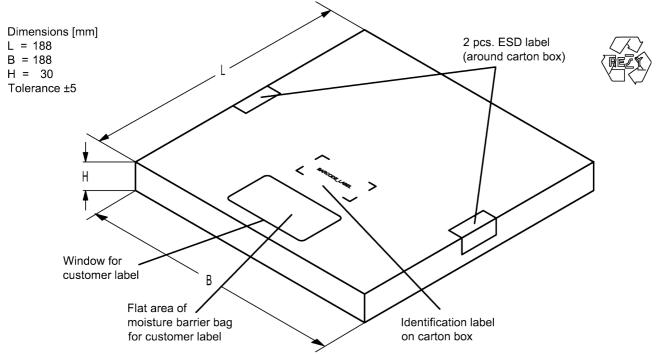


Figure 15: Drawing of folding box for reel with diameter of 180 mm.

12 Marking

Products are marked with product type number and lot number encoded according to Table 2:

■ Type number:

The 4 digit type number of the ordering code, e.g., B3xxxxB1234xxxx, is encoded by a special BASE32 code into a 3 digit marking.

Example of decoding type number marking on device in decimal code.

16J 1234 1234

1 x 32^2 + 6 x 32^1 + 18 (=J) x 32^0

The BASE32 code for product type B4432 is 4AG.

■ Lot number:

The last 5 digits of the lot number, 12345, are encoded based on a special BASE47 code into a 3 digit marking.

Example of decoding lot number marking on device in decimal code.

12345 => $5 \times 47^2 + 27 (=U) \times 47^1 + 31 (=Y) \times 47^0$ 12345

Adopte	Adopted BASE32 code for type number					
Decimal	Base32	Decimal	Base32			
value	code	value	code			
0	0	16	G			
1	1	17	Н			
2	2	18	J			
3	3	19	K			
4	4	20	М			
5	5	21	N			
6	6	22	Р			
7	7	23	Q			
8	8	24	R			
9	9	25	S			
10	Α	26	Т			
11	В	27	V			
12	С	28	W			
13	D	29	Х			
14	E	30	Y			
15	F	31	Z			

Adopted BASE47 code for lot number				
Decimal	Base47	Decimal	Base47	
value	code	value	code	
0	0	24	R	
1	1	25	S	
2	2	26	Т	
3	3	27	U	
4	4	28	V	
5	5	29	W	
6	6	30	X	
7	7	31	Y	
8	8	32	Z	
9	9	33	b	
10	Α	34	d	
11	В	35	f	
12	С	36	h	
13	D	37	n	
14	E	38	r	
15	F	39	t	
16	G	40	V	
17	Н	41	\	
18	J	42	?	
19	K	43	{	
20	L	44	}	
21	М	45	<	
22	Z	46	>	
23	Р			

Table 2: Lists for encoding and decoding of marking.

13 Soldering profile

The recommended soldering process is in accordance with IEC $60068-2-58-3^{rd}$ edit and IPC/JEDEC J-STD-020B.

ramp rate	≤ 3 K/s
preheat	125 °C to 220 °C, 150 s to 210 s, 0.4 K/s to 1.0 K/s
T > 220 °C	30 s to 70 s
T > 230 °C	min. 10 s
T > 245 °C	max. 20 s
<i>T</i> ≥ 255 °C	-
peak temperature T_{peak}	250 °C +0/-5 °C
wetting temperature T _{min}	230 °C +5/-0 °C for 10 s ± 1 s
cooling rate	≤ 3 K/s
soldering temperature <i>T</i>	measured at solder pads

Table 3: Characteristics of recommended soldering profile for lead-free solder (Sn95.5Ag3.8Cu0.7).

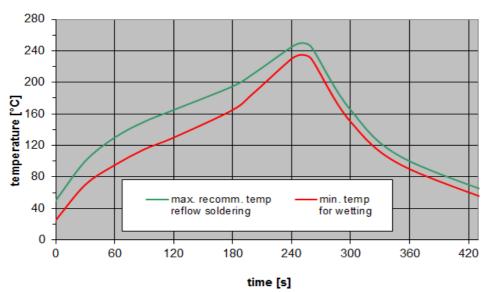


Figure 16: Recommended reflow profile for convection and infrared soldering – lead-free solder.



14 Annotations

14.1 RoHS compatibility

ROHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.

14.2 Scattering parameters (S-parameters)

The pin/port assignment is available in the headers of the S-parameter files. Please contact your local RF360 sales office.

15 Cautions and warnings

15.1 Display of ordering codes for RF360 products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of RF360, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products. Detailed information can be found on the Internet under www.rf360jv.com/orderingcodes.

15.2 Material information

Due to technical requirements components may contain dangerous substances. For information on the type in question please also contact one of our sales offices.

For information on recycling of tapes and reels please contact one of our sales offices.

15.3 Moldability

Before using in overmolding environment, please contact your local RF360 sales office.

15.4 Package information

Landing area

The printed circuit board (PCB) land pattern (landing area) shown is based on RF360 internal development and empirical data and illustrated for example purposes, only. As customers' SMD assembly processes may have a plenty of variants and influence factors which are not under control or knowledge of RF360, additional careful process development on customer side is necessary and strongly recommended in order to achieve best soldering results tailored to the particular customer needs.

Dimensions

Unless otherwise specified all dimensions are understood using unit millimeter (mm).

Dimensions do not include burrs.

Projection method

Unless otherwise specified first-angle projection is applied.



16 Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, RF360 Europe GmbH and its affiliates are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether an RF360 product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.rf360jv.com/material). Should you have any more detailed questions, please contact our sales offices.
- 5. We constantly strive to improve our products. Consequently, the products described in this publication may change from time to time. The same is true of the corresponding product specifications. Please check therefore to what extent product descriptions and specifications contained in this publication are still applicable before or when you place an order. We also reserve the right to discontinue production and delivery of products. Consequently, we cannot guarantee that all products named in this publication will always be available.

The aforementioned does not apply in the case of individual agreements deviating from the foregoing for customer-specific products.

单击下面可查看定价,库存,交付和生命周期等信息

>>RF360 / Qualcomm